APPROVAL SHEET

PRODUCT	**Common Mode Choke (MCM2012B)**
SERIES	MCM2012B
PART NO.	MCM2012B900GBE
DESCRIPTION	2.0X1.2 67~220 OHM Common mode filter
ISSUE DATE	2023/11/22
REVISION DATE	2023/11/22
REFERENCE NO.	0003612XXXXX

RoHS COMPLIANCE ITEM

Halogen Free

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CUSTOMER APPROVAL

CUSTOMER _____ **CUSTOMER PN** _____

■ **Vendor:** Walsin Technology Corporation
566-1, Kao Shi Road, Yangmei, Taiwan
Tel. 886-3-475-3711 www.passivecomponent.com

■ **Manufacturer:** INPAQ Technology Co., Ltd.
No.11, Ke-Yi St., Chunan, Miaoli 35059, Taiwan
Tel. 886-37-585-555 www.inpaq.com.tw

Note:
- The product is subjected to changes in accordance with individual product change notification (PCN) agreement (if any) or Walsin Technology Corporation's policy.
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MCM2012B SERIES (Chip Common Mode Filter) Engineering Specification

RoHS Pb

This product belongs to the industrial grade standard, not the vehicle gauge product! Can not use auto parts, if the customer is not expressly informed and privately used to auto parts, produce any consequences, the original is not responsible for after-sales service, thank you!

Features and Application

. Powerful components with composite co-fired material to solve EMI problem for high speed differential signal transmission line as USB, and LVDS, without distortion to high speed signal transmission.

1. PRODUCT DETAIL

Part No.	Imp. Com. (Ω)±25% @100MHz	DCR Max. (Ω)	Rated Current Max.(mA)	Rated Voltage (V)	Withstand Voltage (V)	Insulation Resistance Min.(MΩ)
MCM2012B670GBE	67	0.40	400	10	25	200
MCM2012B900GBE	90	0.40	400	10	25	200
MCM2012B121GBE	120	0.40	400	10	25	200
MCM2012B161GBE	160	0.50	400	10	25	200
MCM2012B181GBE	180	0.50	400	10	25	200
MCM2012B221FBE	220	0.50	300	10	25	200
Test Instruments	•Agilent E4991A RF IMPEDANCE / MATERIAL ANALYZER •HP4338 MILLIOHMMETER • Agilent E5071C ENA SERIES NETWORK ANALYZER •Keithley 2410 1100V SOURCE METER					

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2. PART NUMBER CODE

MCM	2012	B	90	0	G	B	E
1	2	3	4	5	6	7	8

1 Series Name
2 Size Code: the first two digitals : length(mm), the last two digitals : width(mm)
3 Material Code
4 Impedance(Ω) ± 25%
5 Fixed Decimal Point
(ex : 900=90Ω ; 121=120Ω)
6 Rated Current Code

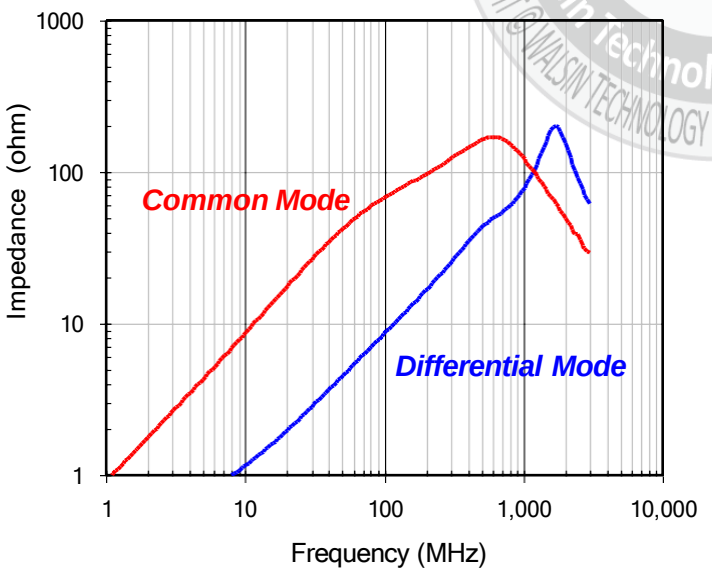
A=50mA	B=80mA	C=100mA	D=150mA	E=200mA	F=300mA
G=400mA	H=500mA	I =600mA	J =700mA	K=800mA	

7 Soldering: Green Parts: A– Soldering Lead-Free B– Lead-Free for whole chip
8 Packaging: E - Embossed plastic tape, 7" reel.

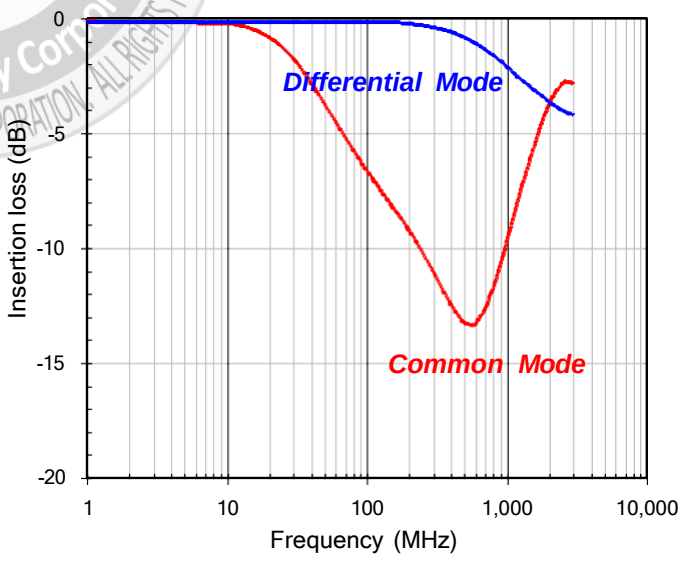
3. TYPICAL CHARACTERISTIC

MCM2012B670

IMPEDANCE vs. FREUQENCY CHARACTERISTICS



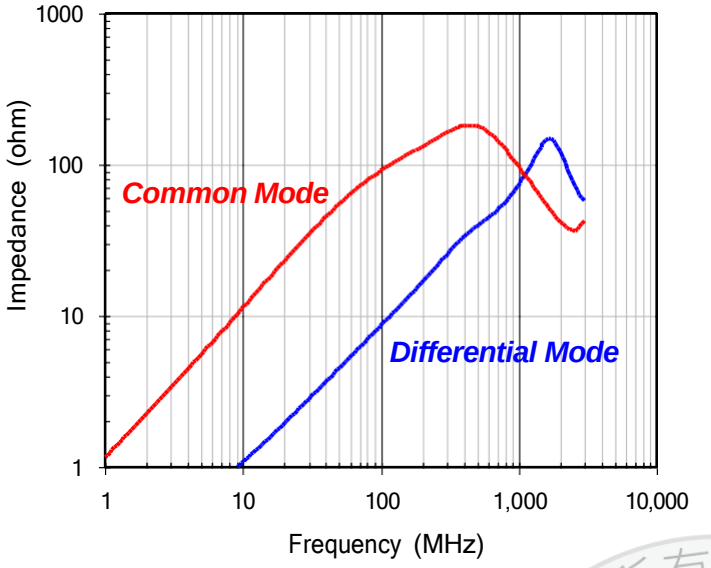
INSERTION LOSS vs. FREUQENCY CHARACTERISTICS



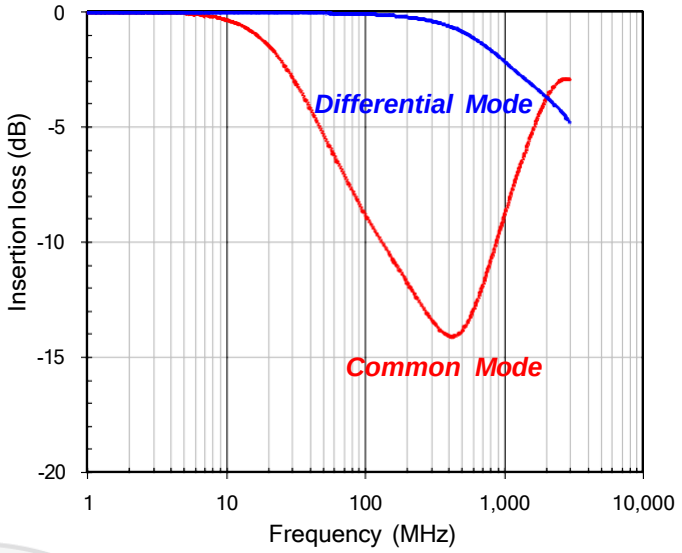
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MCM2012B900

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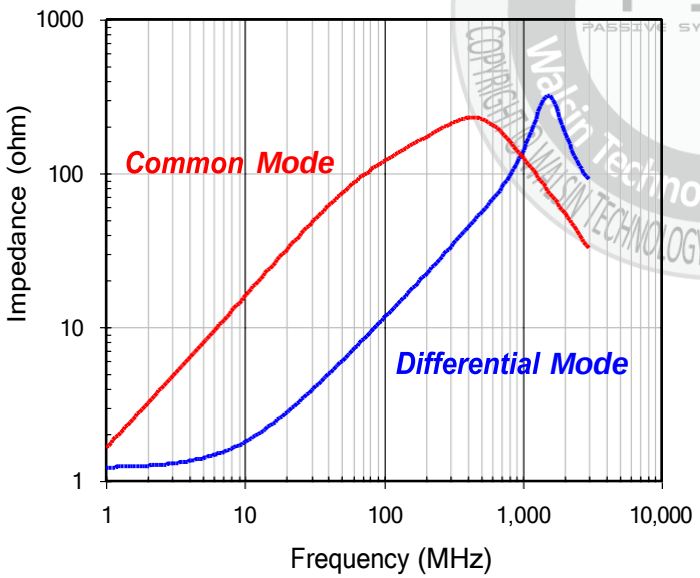


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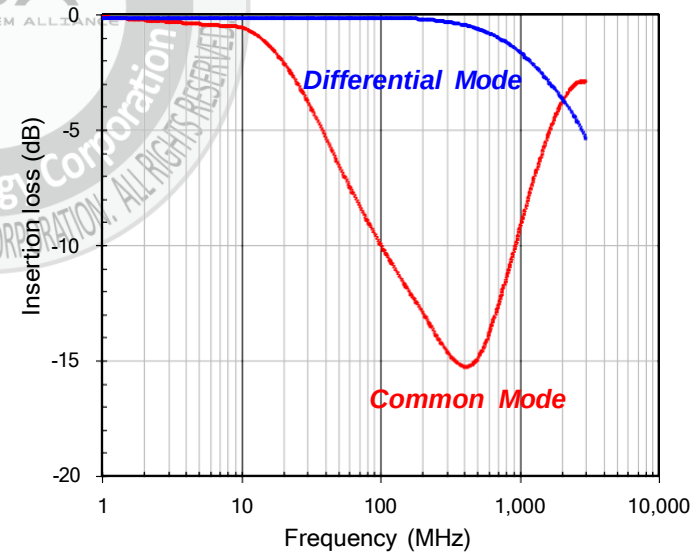


MCM2012B121

IMPEDANCE vs. FREUQENCY CHARACTERISTICS



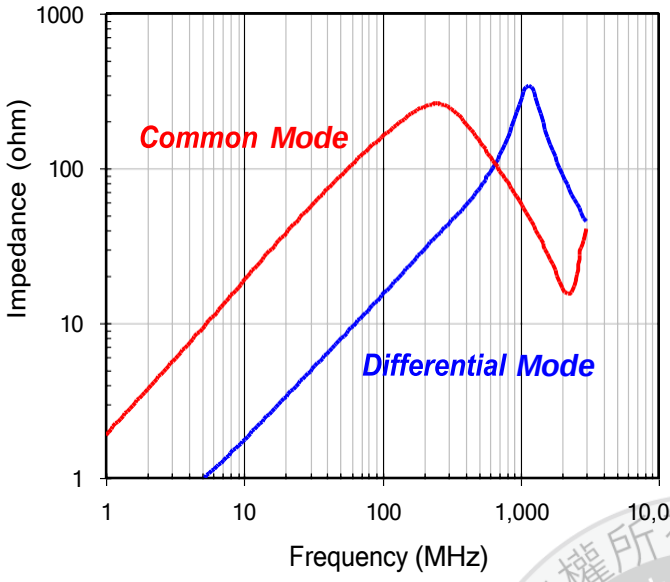
INSERTION LOSS vs. FREUQENCY CHARACTERISTICS



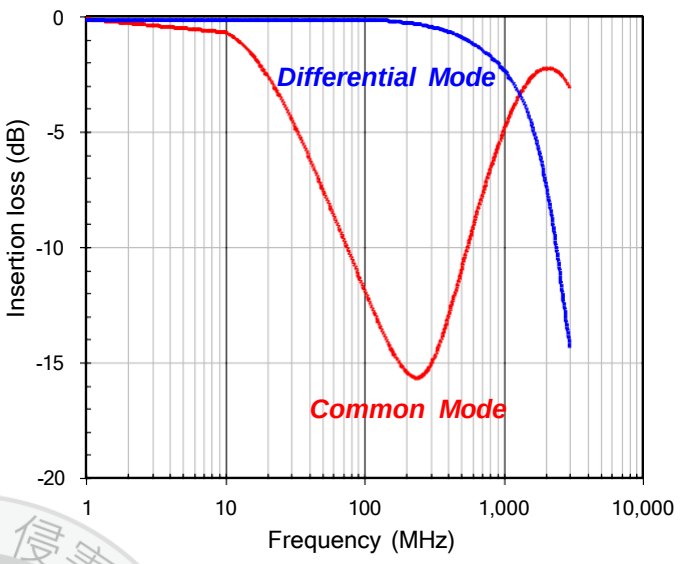
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MCM2012B161

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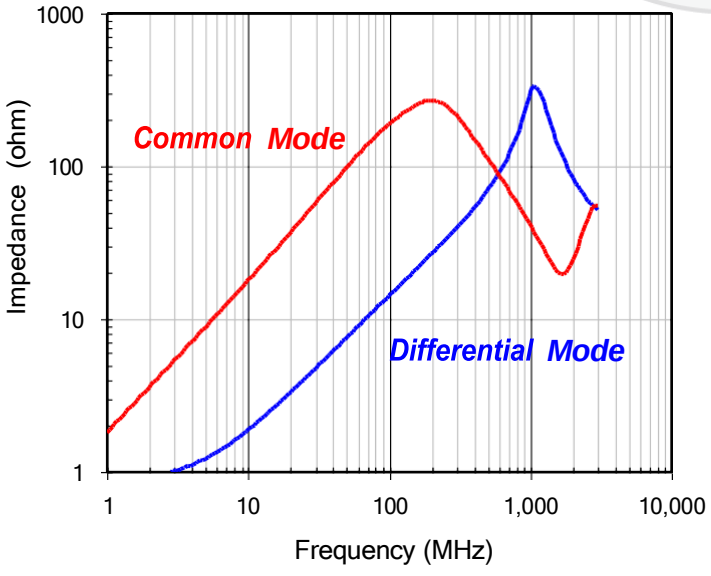
INSERTION LOSS vs. FREUQENCY CHARACTERISTICS



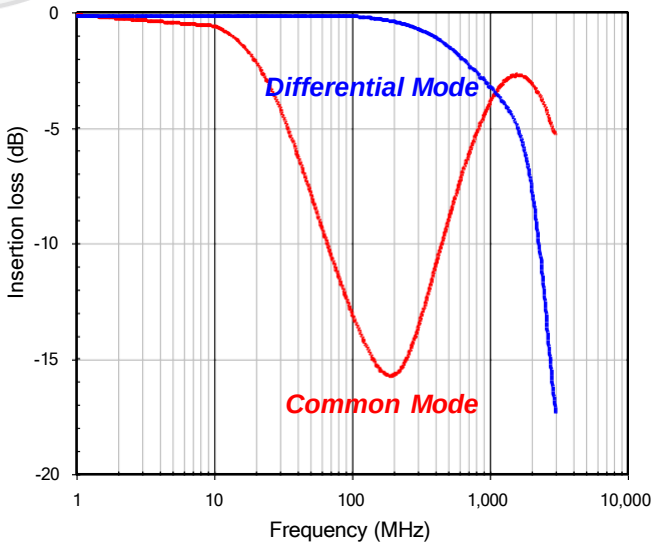
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MCM2012B181

IMPEDANCE vs. FREUQENCY CHARACTERISTICS



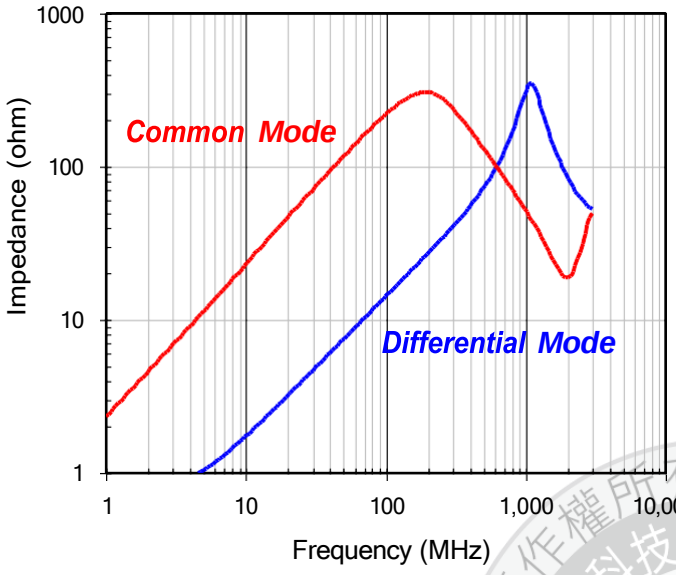
INSERTION LOSS vs. FREUQENCY CHARACTERISTICS



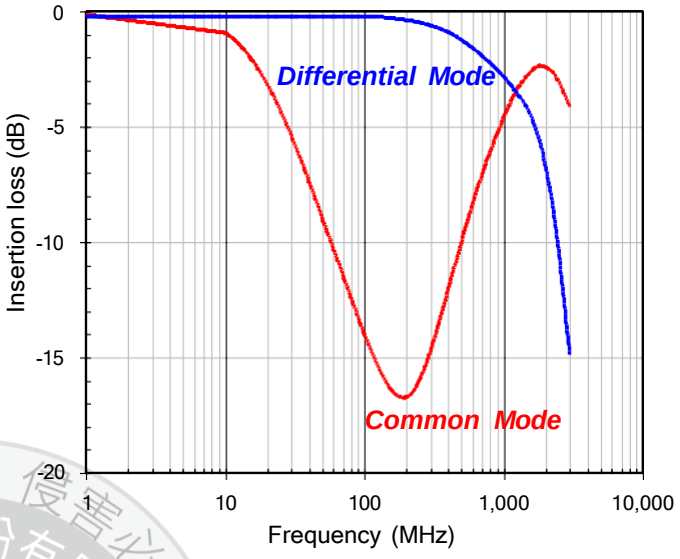
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MCM2012B221

IMPEDANCE vs. FREUQENCY CHARACTERISTICS

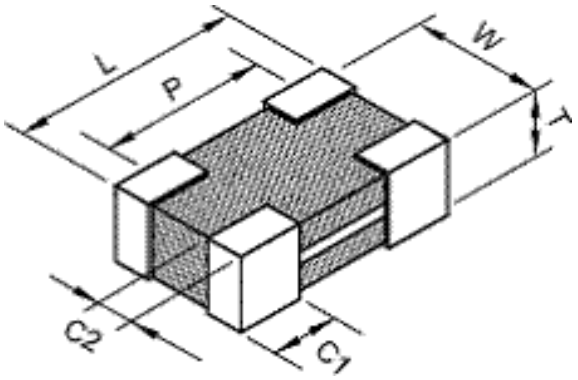


INSERTION LOSS vs. FREUQENCY CHARACTERISTICS



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4. SHAPES AND DIMENSIONS

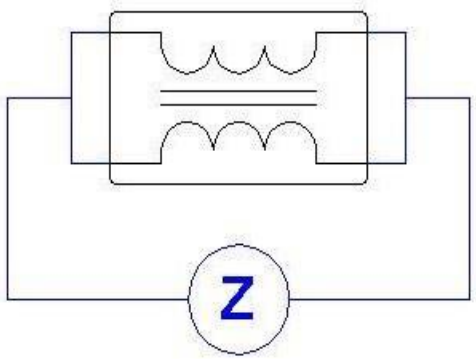


TYPE	2012
L	2.00±0.20
W	1.25±0.20
T	1.00±0.10
P	1.60±0.20
C1	0.40±0.20
C2	0.30±0.20
Unit	mm

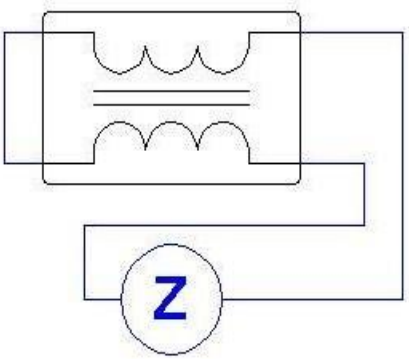
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5. MEASURING CIRCUITS

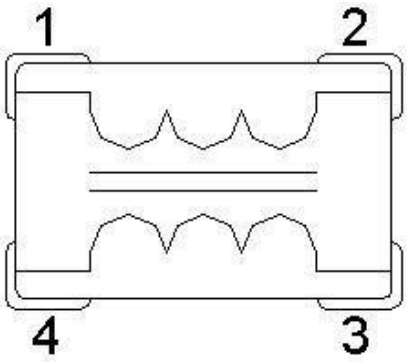
(A):Common mode

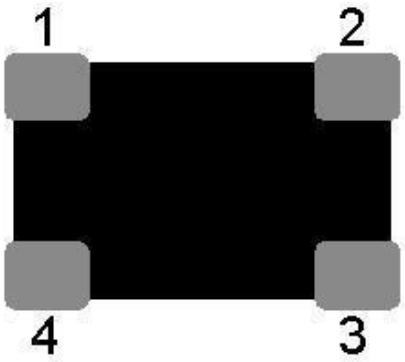


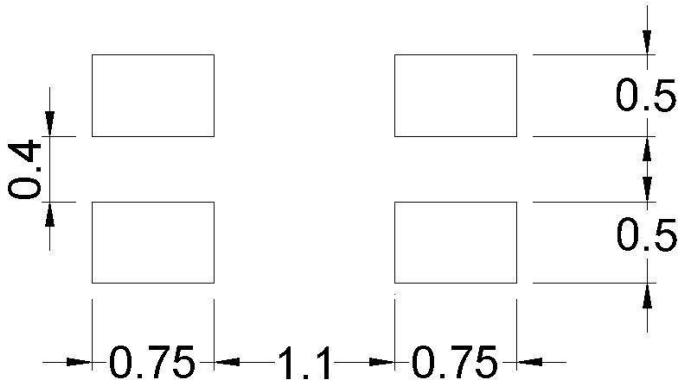
(B):Differential mode



6. CIRCUIT CONFIGURATION & LAYOUT PAD



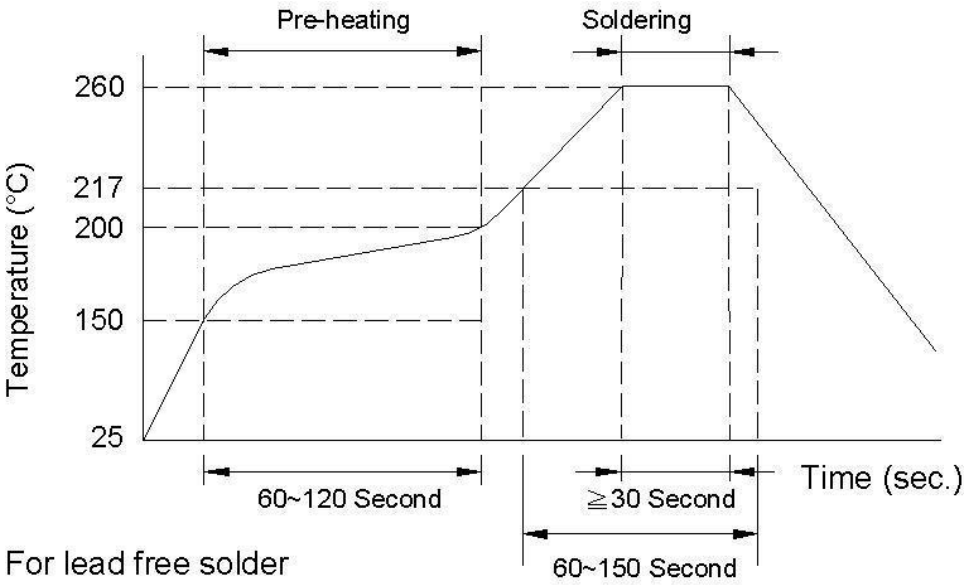




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7. RECOMMENDED SOLDERING CONDITIONS



For lead free solder

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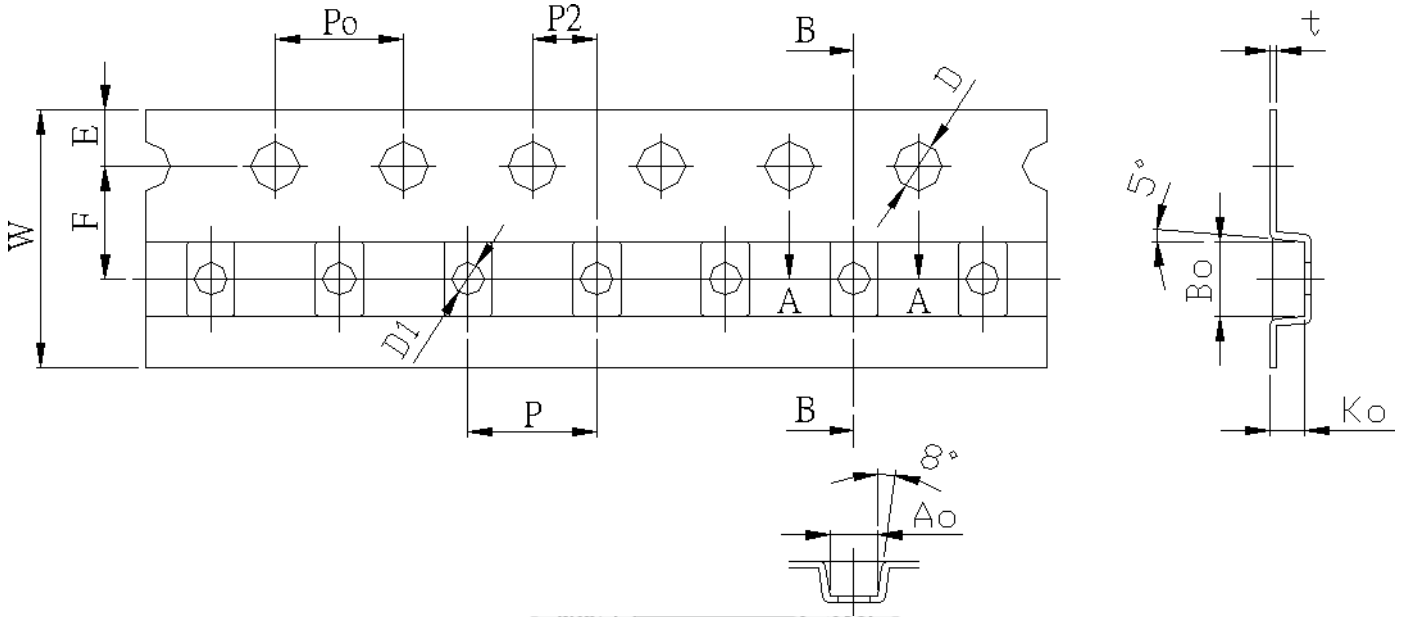
8. RELIABILITY AND TEST CONDITION

Test item	Test condition	Criteria
Thermal Shock	A. Temperature : -40 ~ +85℃ B. Cycle : 100 cycles C. Dwell time : 30minutes Measurement : at ambient temperature 24 hrs after test completion	A. No mechanical damage B. Impedance value should be within ± 20 % of the initial value
Operational Life	A. Temperature : 85℃ ± 5℃ B. Test time : 1000 hrs C. Apply current : full rated current Measurement : at ambient temperature 24 hrs after test completion	A. No mechanical damage B. Impedance value should be within ± 20 % of the initial value
Biased Humidity	A. Temperature : 40 ±2℃ B. Humidity : 90 ~ 95 % RH C. Test time : 1000 hrs D. Apply current : full rated current Measurement : at ambient temperature 24 hrs after test completion	A. No mechanical damage B. Impedance value should be within ± 20 % of the initial value
Resistance to Solder Heat	A. Solder temperature : 260 ± 5℃ B. Flux : Rosin C. DIP time : 10 ± 1 sec	A. More than 95 % of terminal electrode should be covered with new solder B. No mechanical damage C .Impedance value should be within ± 20 % of the initial value
Steam Aging Test	A. Temperature : 93 ± 2℃ B. Test time : 4hr (MCA) Others : 8 hrs C. Solder temperature : 235 ± 5℃ D. Flux : Rosin E. DIP time : 5 ± 1 sec	More than 95 % of terminal electrode should be covered with new solder

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9. TAPE AND REEL SPECIFICATIONS

Type：Plastic Carrier



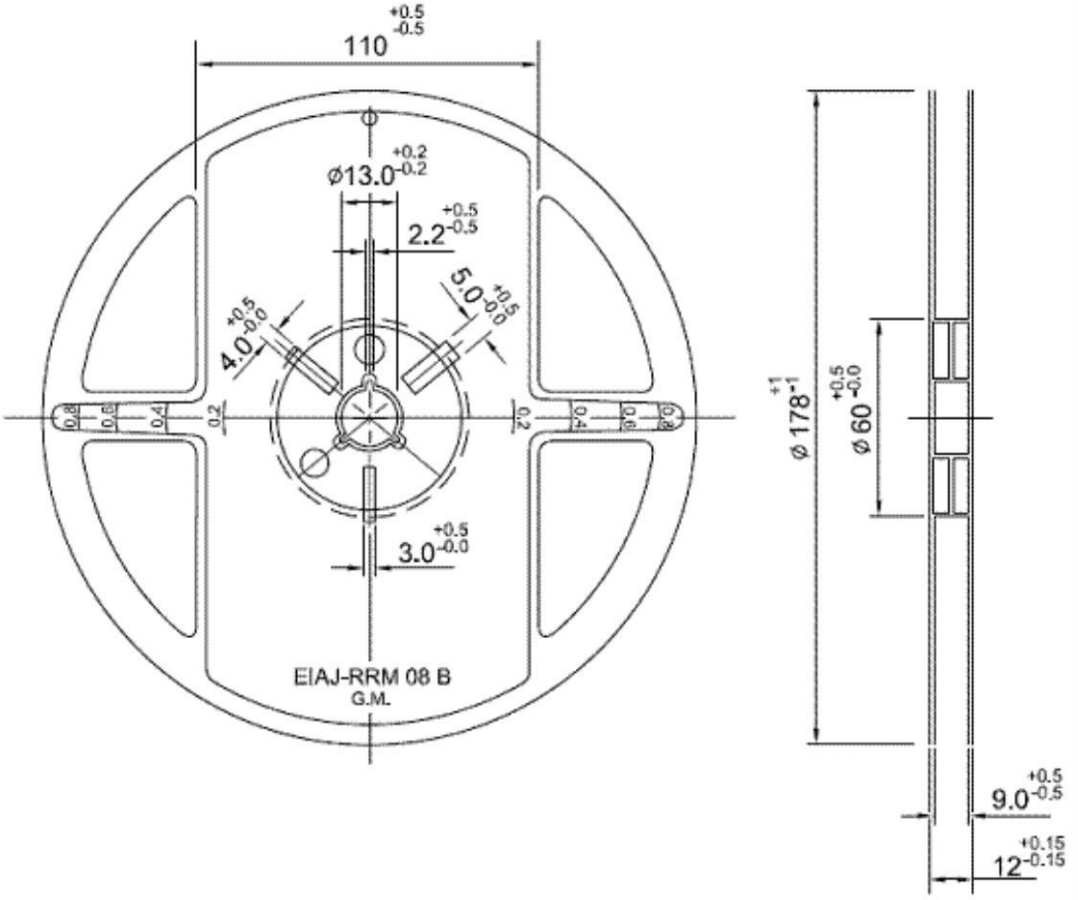
Unit：mm

Symbol	Size	Symbol	Size
W	8.00±0.10	D1	1.00±0.10
P	4.00±0.10	Po	4.00±0.10
E	1.75±0.10	Ao	1.40±0.10
F	3.50±0.05	Bo	2.30±0.10
P2	2.00±0.05	Ko	1.13±0.10
D	$1.50^{+0.10}_{-0.00}$	t	0.22±0.05

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10. REEL DIMENSIONS

Unit: mm



11. STANDARD QUANTITY FOR PACKAGING

Packaging style：Taping

Reel packaging quantity：3000 pcs/reel

Inner box：5 reel/inner box

12. GENERAL TECHNICAL DATA

Operating temperature range : - 40℃ ~ +85℃

Storage Condition : Less than 40℃ and 70% RH

Storage Time: 6 months Max.

Soldering method: Reflow

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